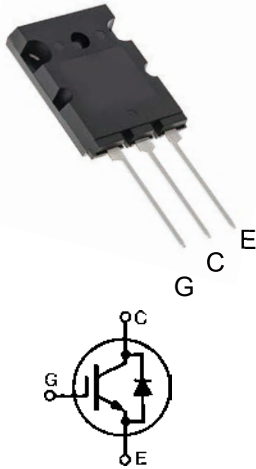


# SG160T60DB3

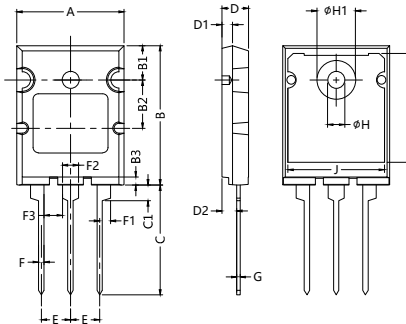
## Discrete IGBTs



SG160T60DB3

G=Gate  
C=Collector  
E=Emitter

### Dimensions in mm



Dim.	Millimeter		Dim.	Millimeter	
	Min.	Max.		Min.	Max.
A	19.50	20.50	E	5.45TYP	
B	25.70	26.30	F	0.90	1.25
B1	5.80	6.20	F1	2.30	2.75
B2	8.80	9.20	F2	2.80	3.20
B3	1.35REF		F3	2.40	/
C	19.50	20.50	G	0.50	0.85
C1	2.20	2.70	H	3.20	3.60
D	4.80	5.20	H1	6.50	7.50
D1	2.00REF		J	16.00	/
D2	2.50	3.10	K	19.00	/



### MAXIMUM RATING (Ta=25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	$V_{CES}$	600	V
Gate-Emitter Voltage	$V_{GES}$	±20	V
Collector Current	$I_C$	@Tc=25°C	160
		@Tc=100°C	80
Pulsed Collector Current	$I_{CM}^*$	300	A
Diode Continuous Forward	@Tc=100°C	$I_F$	80
Current Diode Maximum	$I_{FM}$	300	A
Maximum Power Dissipation	$P_D$	@Tc=25°C	260
		@Tc=100°C	105
Maximum Junction Temperature	$T_j$	150	°C
Storage Temperature Range	$T_{stg}$	-55 to +150	°C

\*

Repetitive rating : Pulse width limited by max. junction temperature

### THERMAL CHARACTERISTIC

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Junction to Case	$R_{thJC}$	0.48	°C/W
(IGBT) Thermal Resistance, Junction to Case	$R_{thJC}$	0.82	°C/W
(DIODE) Thermal Resistance, Junction to Ambient	$R_{thJA}$	24	°C/W

### General Description

SIRECTIFIER Trench Field Stop IGBTs offer low switching losses, high energy efficiency and short circuit ruggedness.

It is designed for applications such as motor control, uninterrupted power supplies(UPS), general inverters.

### FEATURES

- High speed switching
- High ruggedness, temperature stable behavior
- Short Circuit Withstand Times > 10us
- Extremely enhanced avalanche capability

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## Discrete IGBTs

### ELECTRICAL CHARACTERISTICS (Ta=25°C)

SYMBOL	TEST CONDITION	CHARACTERISTIC	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
$B_{V_{CES}}$	$V_{GE}=0V, I_C=250\mu A$	Collector-Emitter Breakdown Voltage	600	-	-	V
$I_{CES}$	$V_{GE}=0V, V_{CE}=600V$	Collector Cut-off Current	-	-	250	$\mu A$
$I_{GES}$	$V_{CE}=0V, V_{GE}=\pm 20V$	Gate Leakage Current	-	-	$\pm 100$	nA
$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=7.5mA$	Gate Threshold Voltage	4.0	5.0	6.5	V
$V_{CE(sat)}$	$V_{GE}=15V, I_C=80A$	Collector-Emitter Saturation Voltage	-	1.95	2.50	V
	$V_{GE}=15V, I_C=160A$		-	2.10	-	V
	$V_{GE}=15V, I_C=80A, T_C = 125^\circ C$		-	1.70	-	V
<b>Dynamic</b>						
$Q_g$	$V_{CC}=300V, V_{GE}=15V, I_C= 80A$	Total Gate Charge	-	350	-	nC
$Q_{ge}$		Gate-Emitter Charge	-	60	-	nC
$Q_{gc}$		Gate-Collector Charge	-	100	-	nC
$t_{d(on)}$	$V_{CC}=300V, I_C=80A, V_{GE}=15V,$ $R_G=10\Omega$ Inductive Load, $T_C = 25^\circ C$ (Note 1)	Turn-On Delay Time	-	40	-	ns
$t_r$		Rise Time	-	100	-	ns
$t_{d(off)}$		Turn-Off Delay Time	-	100	-	ns
$t_f$		Fall Time	-	80	-	ns
$E_{on}$		Turn-On Switching Loss	-	2.5	3.75	mJ
$E_{off}$		Turn-Off Switching Loss	-	1.75	3.25	mJ
$E_{ts}$		Total Switching Loss	-	4.3	6.9	mJ
$t_{d(on)}$		$V_{CC}=300V, I_C=75A, V_{GE}=15V,$ $R_G=10\Omega$ Inductive Load, $T_C = 125^\circ C$ (Note 1)	Turn-On Delay Time	-	100	-
$t_r$	Rise Time		-	60	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	240	-	ns
$t_f$	Fall Time		-	50	-	ns
$E_{on}$	Turn-On Switching Loss		-	3.0	-	mJ
$E_{off}$	Turn-Off Switching Loss		-	2.65	-	mJ
$E_{ts}$	Total Switching Loss		-	5.6	-	mJ
$C_{ies}$	$V_{CE}=30V, V_{GE}=0V, f=1MHz$		Input Capacitance	-	5050	-
$C_{oes}$		Output Capacitance	-	550	-	pF
$C_{res}$		Reverse Transfer Capacitance	-	180	-	pF
$t_{sc}$	$V_{CC}=300V, V_{GE}=15V, T_C=100^\circ C$	Short Circuit Withstand Time	10	-	-	$\mu s$

Note 1 : Energy loss include tail current and diode reverse recovery.

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## Discrete IGBTs

### ELECTRICAL CHARACTERISTIC OF DIODE

SYMBOL	TEST CONDITION		CHARACTERISTIC	MIN.	TYP.	MAX.	UNIT
$V_F$	$I_F = 25A$	$T_C = 25^\circ C$	Diode Forward Voltage	-	1.4	1.6	V
		$T_C = 125^\circ C$		-	1.3	-	
$t_{rr}$	$V_{CC} = 300V,$ $I_F = 80A$ $di/dt = 600A/\mu s$	$T_C = 25^\circ C$	Diode Reverse Recovery Time	-	50	-	ns
		$T_C = 125^\circ C$		-	100	-	
$I_{rr}$		$T_C = 25^\circ C$	Diode Peak Reverse Recovery Current	-	5	-	A
		$T_C = 125^\circ C$		-	8.5	-	
$Q_{rr}$		$T_C = 25^\circ C$	Diode Reverse Recovery Charge	-	110	-	$\mu C$
		$T_C = 125^\circ C$		-	400	-	

Fig 1. Forward Characteristics

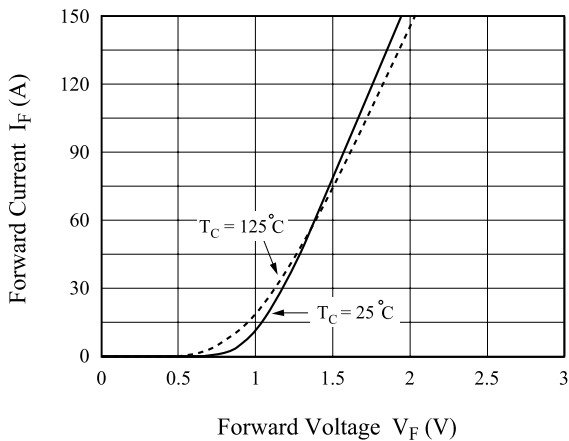


Fig 2. Reverse Recovery Current

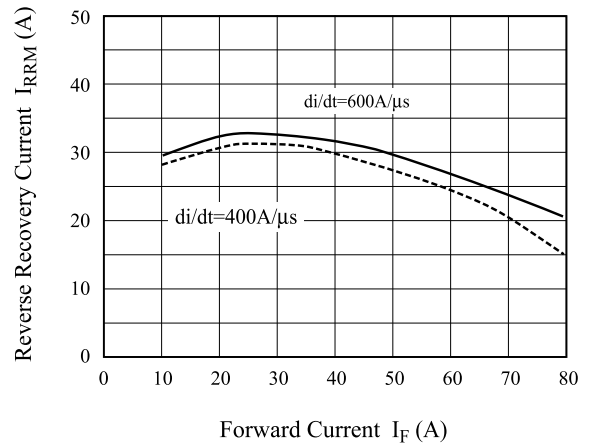
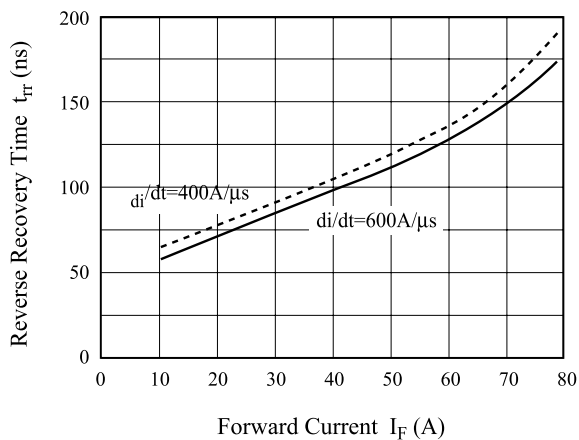


Fig 3. Reverse Recovery Time



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## Discrete IGBTs

Fig 4. Saturation Voltage Characteristics

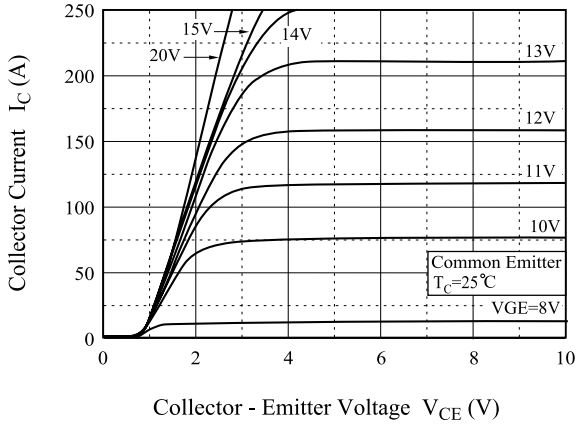


Fig 5. Saturation Voltage Characteristics

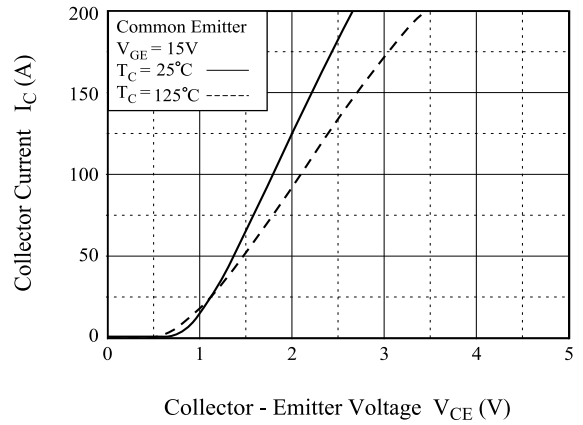


Fig 6. Saturation Voltage vs. Case Temperature

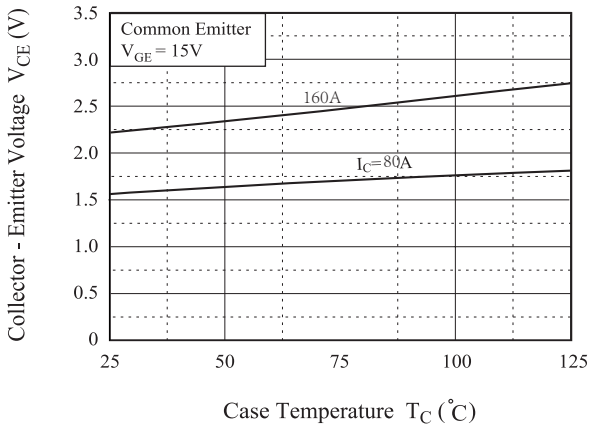


Fig 7. Saturation Voltage vs.  $V_{GE}$

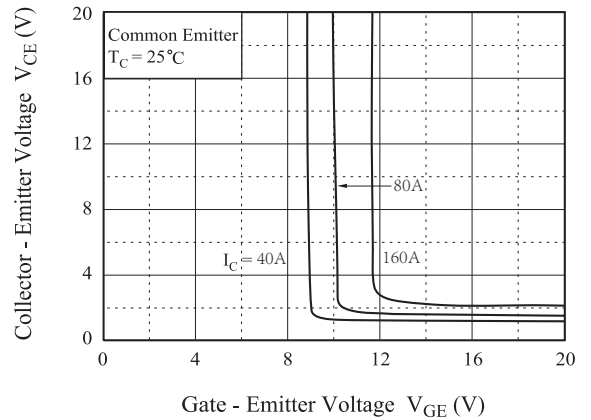


Fig 8. Saturation Voltage vs.  $V_{GE}$

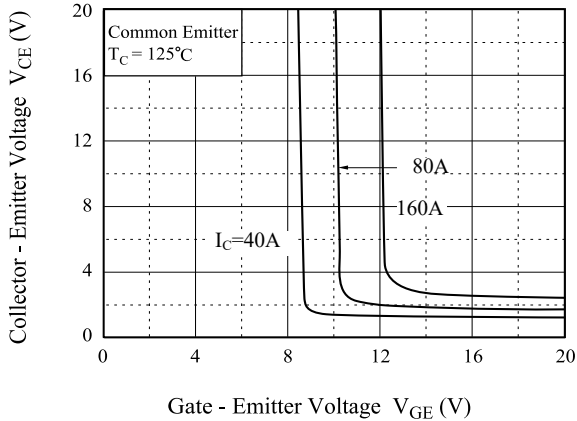
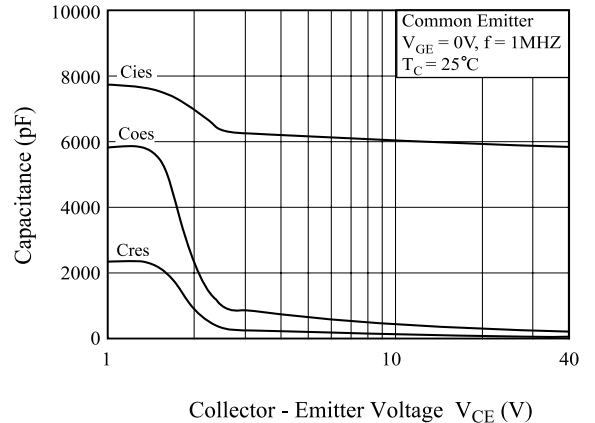


Fig 9. Capacitance Characteristics



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## Discrete IGBTs

Fig 10. Turn-On Characteristics vs. Gate Resistance

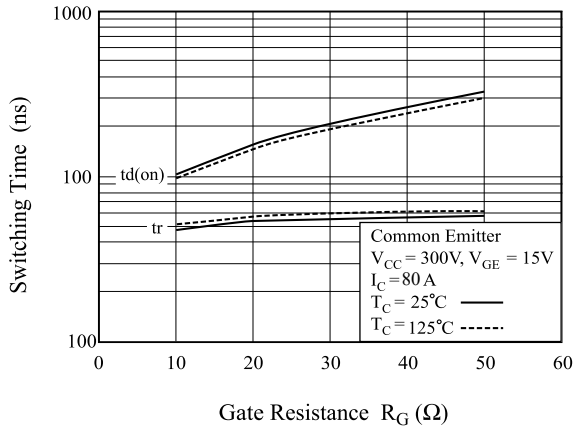


Fig 11. Turn-Off Characteristics vs. Gate Resistance

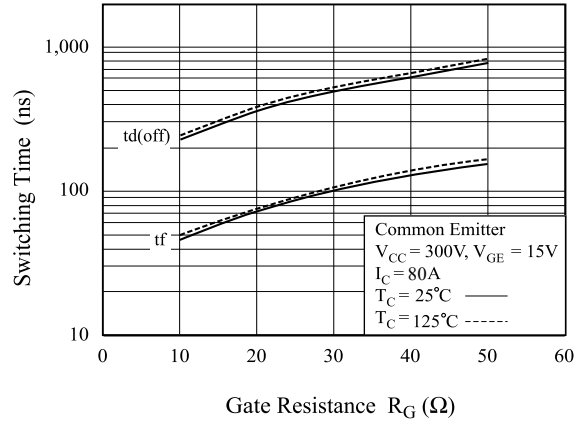


Fig 12. Switching Loss vs. Gate Resistance

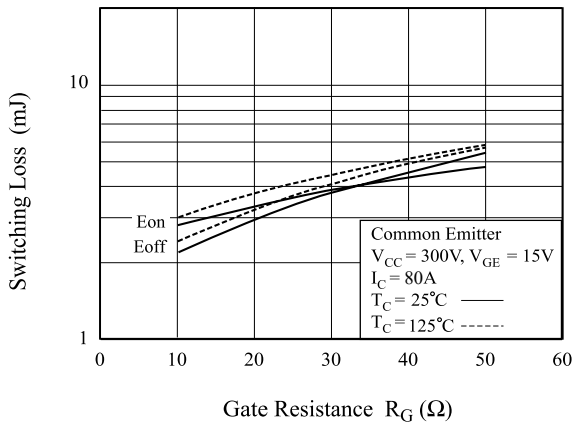


Fig 13. Turn-On Characteristics vs. Collector Current

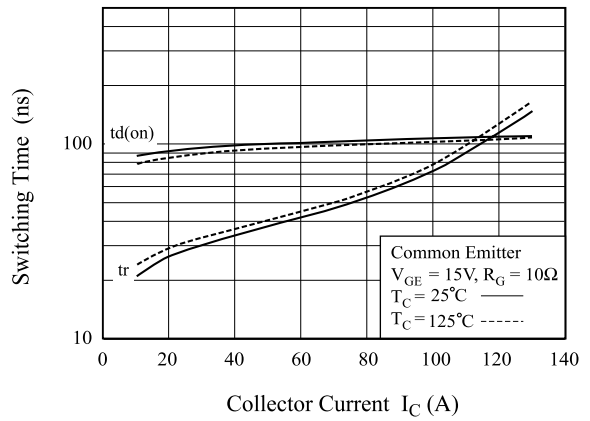


Fig 14. Turn-Off Characteristics vs. Collector Current

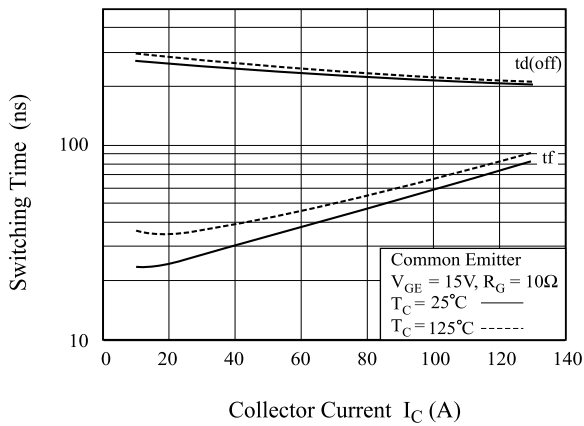
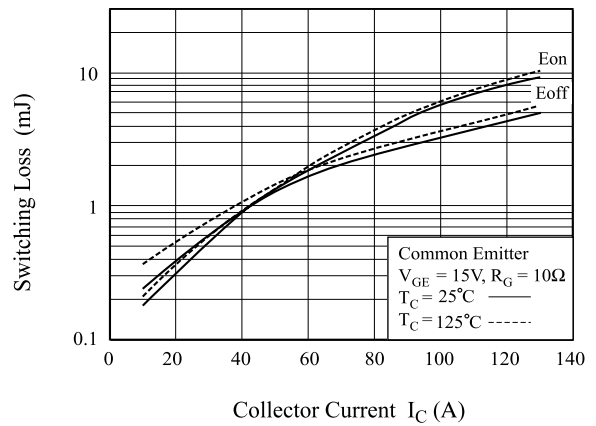


Fig 15. Switching Loss vs. Collector Current



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## Discrete IGBTs

Fig 16. Gate Charge Characteristics

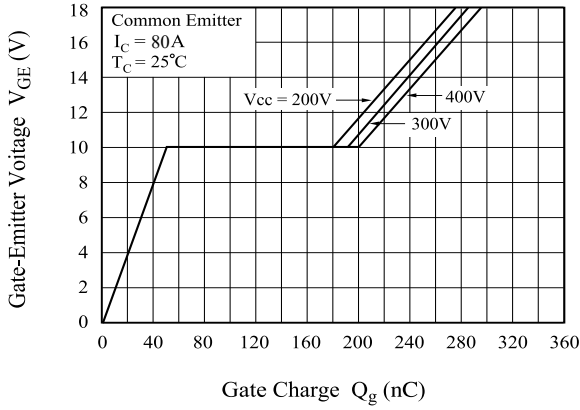


Fig 17. SOA Characteristics

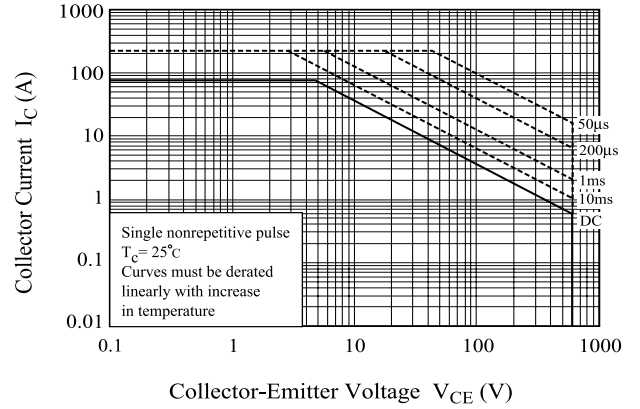


Fig 18. Turn-Off SOA

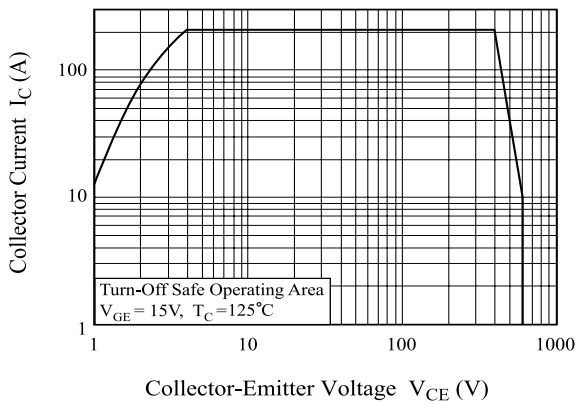
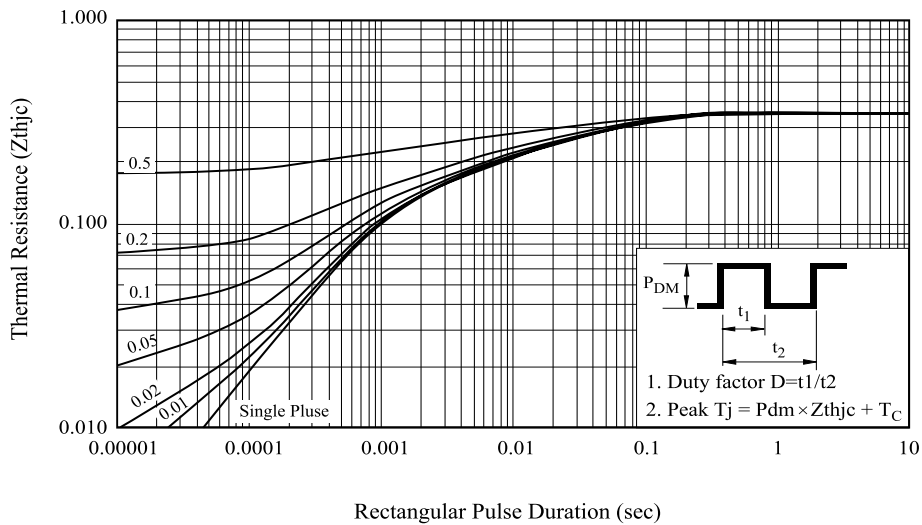


Fig 19. Transient Thermal Impedance of IGBT



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## Discrete IGBTs

Fig.20 Switching Test Circuit

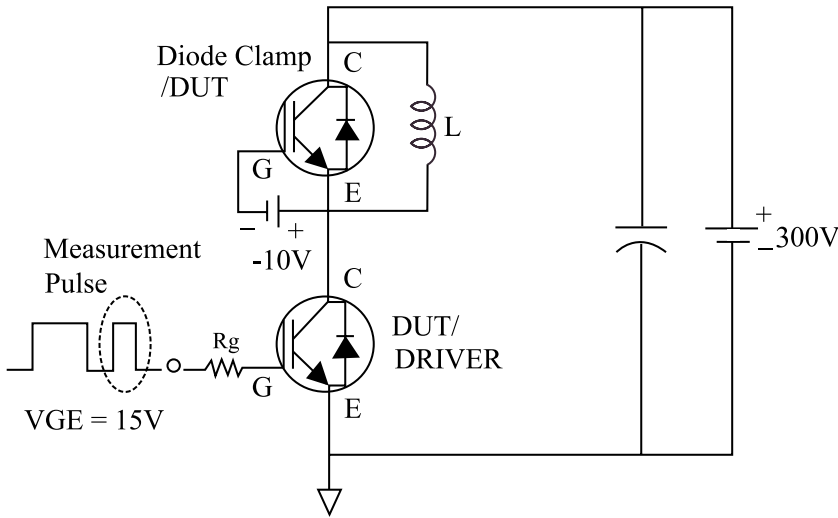


Fig.21 Definition Switching Time & Loss

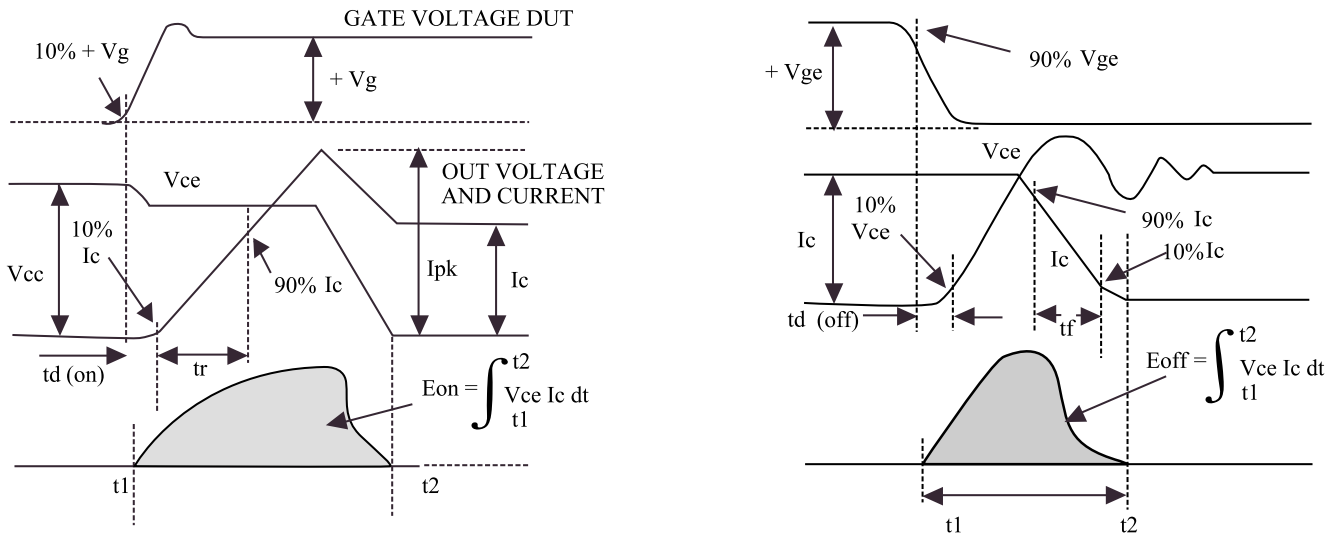


Fig.22 Definition Diode Switching Time

